2SA715

Silicon PNP Epitaxial

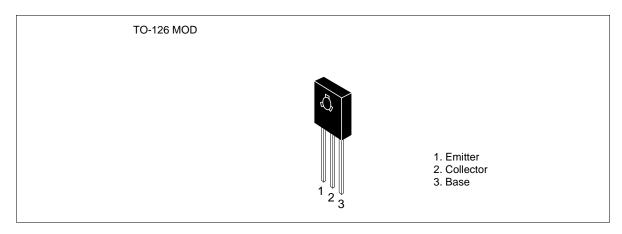
HITACHI

ADE-208-852 (Z) 1st. Edition Sep. 2000

Application

Low frequency power amplifier complementary pair with 2SC1162

Outline



Absolute Maximum Ratings $(Ta = 25^{\circ}C)$

Item	Symbol	Rating	Unit
Collector to base voltage	V _{CBO}	-35	V
Collector to emitter voltage	V _{CEO}	-35	V
Emitter to base voltage	V_{EBO}	- 5	V
Collector current	I _c	-2.5	A
Collector peak current	I _{C(peak)}	-3	A
Collector power dissipation	P _c	0.75	W
	P _c *1	10	W
Junction temperature	Tj	150	°C
Storage temperature	Tstg	-55 to +150	°C

Note: 1. Value at $T_c = 25^{\circ}C$



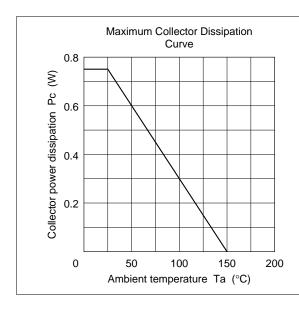
2SA715

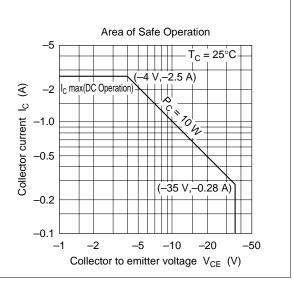
Electrical Characteristics ($Ta = 25^{\circ}C$)

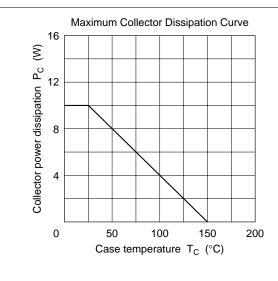
Item	Symbol	Min	Тур	Max	Unit	Test conditions
Collector to base breakdown voltage	$V_{(BR)CBO}$	-35	_	_	V	$I_{\rm C} = -1 \text{ mA}, I_{\rm E} = 0$
Collector to emitter breakdown voltage	$V_{(BR)CEO}$	-35	_	_	V	$I_{\rm C} = -10$ mA, $R_{\rm BE} = \infty$
Emitter to base breakdown voltage	$V_{(BR)EBO}$	– 5	_	_	V	$I_{\rm E} = -1 \text{mA}, I_{\rm C} = 0$
Collector cutoff current	I _{CBO}	_	_	-20	μΑ	$V_{CB} = -35 \text{ V}, I_{E} = 0$
DC current transfer ratio	h _{FE} *1	60	_	320		$V_{CE} = -2 \text{ V}, I_{C} = -0.5 \text{ A}$
	h_{FE}	20	_	_		$V_{CE} = -2 \text{ V}, I_{C} = -1.5 \text{ A}$ (Pulse test)
Base to emitter voltage	V_{BE}	_	-1.0	-1.5	V	$V_{CE} = -2 \text{ V}, I_{C} = -1.5 \text{ A}$ (Pulse test)
Collector to emitter saturation voltage	$V_{\text{CE(sat)}}$	_	-0.5	-1.0	V	$I_{\rm C} = -2$ A, $I_{\rm B} = -0.2$ A (Pulse test)
Gain bandwidth product	f _T	_	160	_	MHz	$V_{CE} = -2 \text{ V}, I_{C} = -0.2 \text{ A}$ (Pulse test)

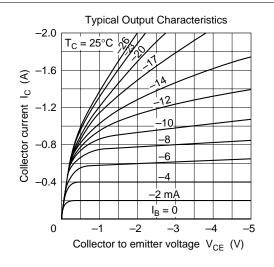
Note: 1. The 2SA715 is grouped by h_{FE} as follows.

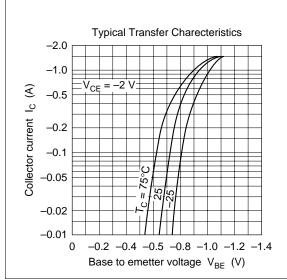
В	С	D
60 to 120	100 to 200	160 to 320

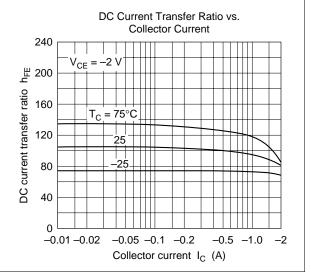




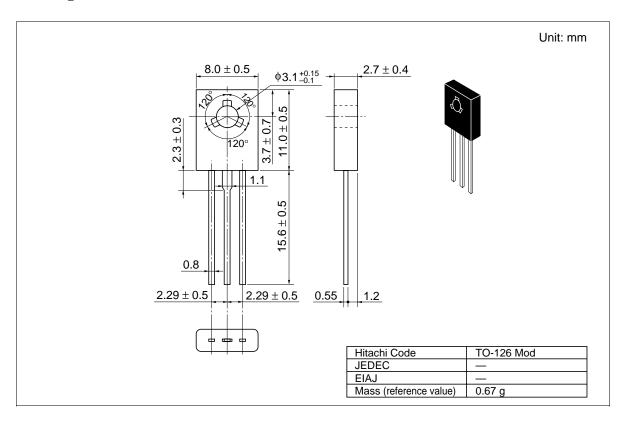








Package Dimensions



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Hitachi, Ltd.

Semiconductor & Integrated Circuits. Nippon Bldg., 2-6-2, Ohte-machi, Chiyoda-ku, Tokyo 100-0004, Japan

Tel: Tokyo (03) 3270-2111 Fax: (03) 3270-5109

URL NorthAmerica Europe Asia Japan

http://semiconductor.hitachi.com/ http://www.hitachi-eu.com/hel/ecg http://sicapac.hitachi-asia.com http://www.hitachi.co.jp/Sicd/indx.htm

For further information write to:

Hitachi Semiconductor (America) Inc. 179 East Tasman Drive, San Jose,CA 95134 Tel: <1> (408) 433-1990 Germany Fax: <1>(408) 433-0223

Hitachi Europe GmbH Electronic Components Group Dornacher Straße 3 D-85622 Feldkirchen, Munich

Tel: <49> (89) 9 9180-0 Fax: <49> (89) 9 29 30 00

Hitachi Europe Ltd. Electronic Components Group. Whitebrook Park Lower Cookham Road

Maidenhead Berkshire SL6 8YA, United Kingdom Tel: <44> (1628) 585000 Fax: <44> (1628) 585160

Hitachi Asia Ltd. Hitachi Tower 16 Collyer Quay #20-00, Singapore 049318 Tel: <65>-538-6533/538-8577 Fax: <65>-538-6933/538-3877 URL: http://www.hitachi.com.sg

Hitachi Asia I td (Taipei Branch Office)

4/F, No. 167, Tun Hwa North Road, Hung-Kuo Building. Taipei (105), Taiwan Tel: <886>-(2)-2718-3666

Fax: <886>-(2)-2718-8180 Telex: 23222 HAS-TP URL: http://www.hitachi.com.tw Group III (Electronic Components) 7/F., North Tower, World Finance Centre, Harbour City, Canton Road Tsim Sha Tsui, Kowloon, Hong Kong

Hitachi Asia (Hong Kong) Ltd.

Tel: <852>-(2)-735-9218 Fax: <852>-(2)-730-0281 URL: http://www.hitachi.com.hk

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